PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shih-Yin Hsiao	06/09/2015
Kuan-Liang Liu	06/09/2015

RECEIVING PARTY DATA

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State/Country:	TAIWAN		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14859348

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SIGNATURE:	/SIBYL YU/
DATE SIGNED:	09/20/2015

Total Attachments: 4

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PATENT 503487330 REEL: 036606 FRAME: 0476

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

ISOLATION STRUCTURE AND METHOD FOR FABRICATING THE SAME

As the below named inventor, I here This declaration is directed to:	eby declare that:			
☑ The attached application, or	•			
☐ United States application nu	filed on	, or		
□ PCT international application number		filed o		
The above-identified application was	s made or authorized to be ma	de by me.		
I believe that I am the original inventage application.	tor or an original joint inventor	of a claimed inv	rention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impi	ul false statement made in this risonment of not more than five	declaration is p (5) years, or b	unishable oth.	
In consideration of the payment by	UNITED MICROELECTR	ONICS ha	ving a postal address	of
No.3, Li-Hsin Road 2, Science	e-Based Industrial Park, I		y 300, Taiwan, R.C).C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good are	o I of the sum of One Dollar (\$ nd valuable consideration.	1.00), the rece	pt of which is hereby	
I hereby sell, assign and transfer to a the entire right, title and interest in a invention as above-identified applica invention by the above application o substitutes, or extensions thereof, an	nd to any and all improvement: ation and, in and to, all Letters I r any continuations, continuation	s which are disc Patent to be ob on-in-part, divis	closed in the tained for said ions, renewals	
I hereby covenant that no assignment that no assignment that entered into which would conflict with the conflict with th	nt, sale, agreement or encumb h this assignment;	rance has beer	or will be made or	
I further covenant that ASSIGNEE wand documents relating to said inver known and accessible to I and will te related thereto and will promptly exe	ntion and said Letters Patent are estify as to the same in any inte	nd legal equiva erference, litigat	ents as may be	
representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be ne IN WINTNESS WHEREOF, I have h	olication, said invention and sai	id Letters Pater out the propose	it and said s thereof.	ning)
Note: An application data sheet (PT0 inventive entity, must accompany thi	O/SB/14 or equivalent), includir is form. Use this form for each	ng naming the e	entire ntor.	

Page 1 of 4

F#NPO-P0002E-US1201 DSC0-104U006764

Docket No NAUP2525USA

Inventor: Shih-Yin Hsiao Date: 06/09/2015

Signature: Shift - Yam Hkiao

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COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

ISOLATION STRUCTURE AND METHOD FOR FABRICATING THE SAME

As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application number		filed on	, or
□ PCT international application number		filed on	
The above-identified application was	s made or authorized to be made	e by me.	***************************************
I believe that I am the original invent application.	or or an original joint inventor of	a claimed invention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr	I false statement made in this do isonment of not more than five (eclaration is punishable 5) years, or both.	
In consideration of the payment by	UNITED MICROELECTRO	ONICS having a postal a	ddress of
No.3, Li-Hsin Road 2, Science	-Based Industrial Park, H	sin-Chu City 300, Taiwa	an, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good ar	o I of the sum of One Dollar (\$ 1 ad valuable consideration.	.00), the receipt of which is I	hereby
I hereby sell, assign and transfer to a the entire right, title and interest in an invention as above-identified applical invention by the above application of substitutes, or extensions thereof, ar	nd to any and all improvements tion and, in and to, all Letters Pa any continuations, continuation	which are disclosed in the atent to be obtained for said in part, divisions, renewals	:
I hereby covenant that no assignment entered into which would conflict with	nt, sale, agreement or encumbra n this assignment;	nce has been or will be mad	de or
I further covenant that ASSIGNEE w and documents relating to said inver- known and accessible to I and will te related thereto and will promptly exe	ition and said Letters Patent and stify as to the same in any intert	I legal equivalents as may be erence, litigation proceeding	e
representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be ne IN WINTNESS WHEREOF, I have he	lication, said invention and said cessary or desirable to carry ou	Letters Patent and said the proposes thereof.	e of signing)
Note: An application data sheet (PTC inventive entity, must accompany this	D/SB/14 or equivalent), including s form. Use this form for each ac	naming the entire	

Page 3 of 4

F#NPO-P0002E-US1201 DSC0-104U006764

Docket No NAUP2525USA

LEGAL NAI	ME OF INVENTOR(ASSIGNOR)				
Inventor:	Kuan-Liang Liu		Date:	JUN 0 9 2015	
Signature:	Xuar-Liang	Liu			

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NPO#NAU-P2525-USA:0 CUST#UMCD-2015-0140

RECORDED: 09/20/2015

F#NPO-P0002E-US1201 DSC0-104U006764

PATENT REEL: 036606 FRAME: 0480